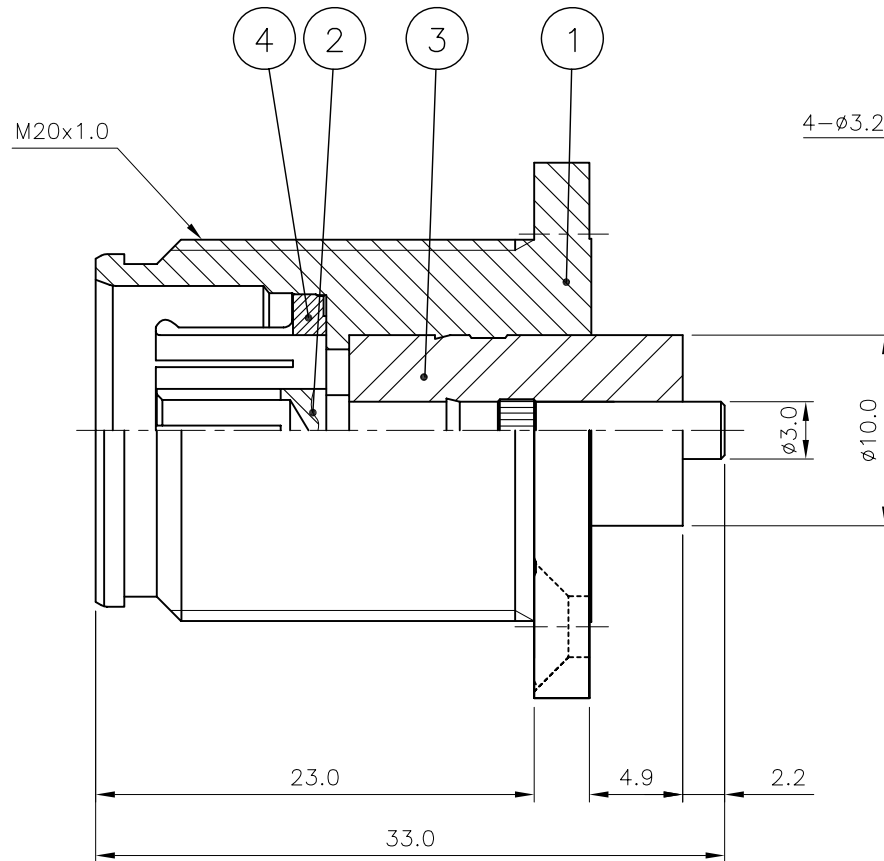
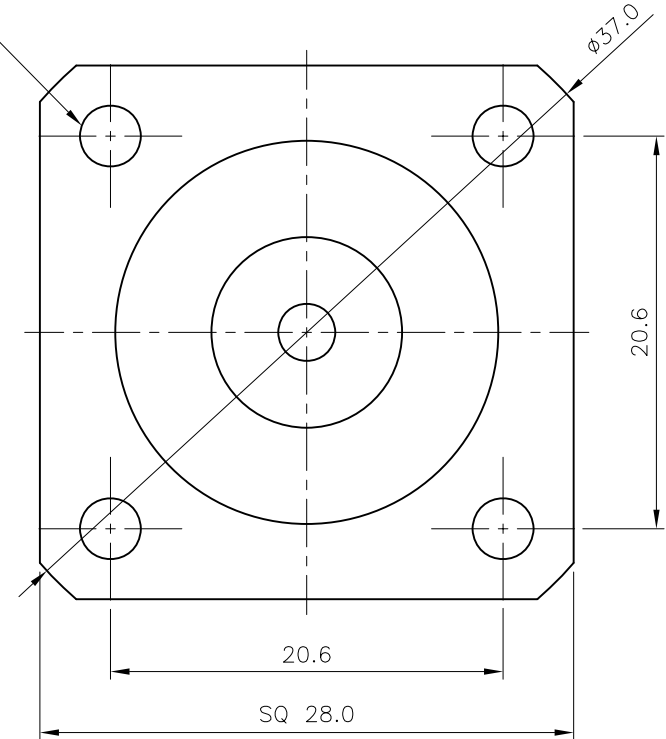


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	T.J.KIM	J.H.YOUN	2016. 06. 30.



4- $\phi 3.2$ THRU



4	JACK	1	MBsBD C3604BD-F	Silver Plate (3 μ m)	DJA00228-5/3
3	INSULATOR	1	TEFLON		DIN02794-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (5 μ m)	DCT03720-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate (3 μ m)	DBD04187-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ± 0.1	DATE 2016. 06. 30.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle $\pm 1^\circ$	APPROVED BY	J.H.YOUN			
MATERIAL _____		CHECKED BY	S.L.SON		TITLE 4.3-10 SOLDER END JS-4H	
		DRAWN BY	T.J.KIM			
FINISH _____		SCALE 2.5/1	UNIT mm		A4	DWG NO. CN03626-7/1
						REVISION 1